

N-channel 30 V, 0.021 Ω typ., 6 A STripFET™ VI DeepGATE™ Power MOSFET in a SOT23-6L package

Datasheet - production data

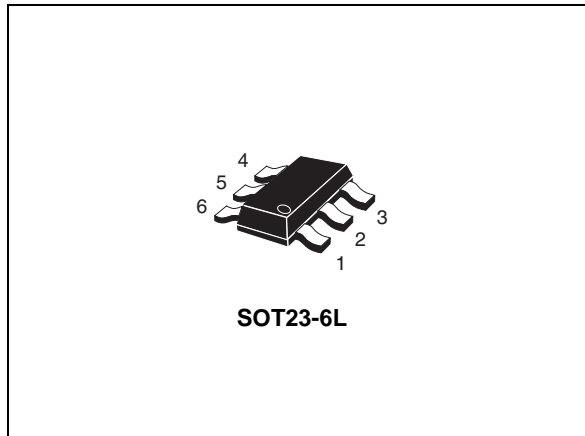
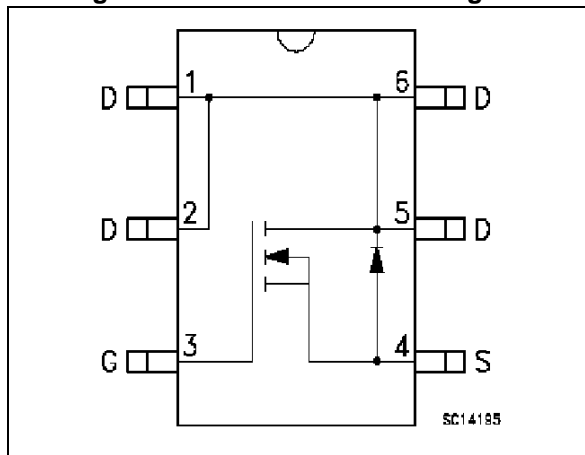


Figure 1. Internal schematic diagram



Features

Order code	V _{DSS}	R _{DS(on)} max	I _D	P _{TOT}
STT6N3LLH6	30 V	0.025 Ω (V _{GS} = 10 V)	6 A	1.6 W
		0.036 Ω (V _{GS} = 4.5 V)		

- R_{DS(on)} * Q_g industry benchmark
- Extremely low on-resistance R_{DS(on)}
- High avalanche ruggedness
- Low gate drive power losses

Applications

- Switching applications

Description

This device is an N-channel Power MOSFET developed using the 6th generation of STripFET™ DeepGATE™ technology, with a new gate structure. The resulting Power MOSFET exhibits the lowest R_{DS(on)} in all packages.

Table 1. Device summary

Order code	Marking	Package	Packaging
STT6N3LLH6	STG1	SOT23-6L	Tape and reel

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1 Electrical ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V_{DS}	Drain-source voltage	30	V
V_{GS}	Gate-source voltage	± 20	V
I_D	Drain current (continuous) at $T_{pcb} = 25\text{ }^\circ\text{C}$	6	A
I_D	Drain current (continuous) at $T_{pcb} = 100\text{ }^\circ\text{C}$	3.75	A
$I_{DM}^{(1)}$	Drain current (pulsed)	24	A
P_{TOT}	Total dissipation at $T_C = 25\text{ }^\circ\text{C}$	1.6	W
	Derating factor	0.013	W/ $^\circ\text{C}$
T_{stg}	Storage temperature	-55 to 150	$^\circ\text{C}$
T_j	Max. operating junction temperature	150	$^\circ\text{C}$

1. Pulse width limited by safe operating area

Table 3. Thermal resistance

Symbol	Parameter	Value	Unit
$R_{thj-pcb}^{(1)}$	Thermal resistance junction-pcb max	78	$^\circ\text{C}/\text{W}$

1. When mounted on FR-4 board of 1 inch², 2oz Cu, t < 10 sec

2 Electrical characteristics

($T_{CASE} = 25\text{ °C}$ unless otherwise specified).

Table 4. Static

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$V_{(BR)DSS}$	Drain-source breakdown Voltage	$I_D = 250\ \mu\text{A}$, $V_{GS} = 0$	30			V
I_{DSS}	Zero gate voltage drain current ($V_{GS} = 0$)	$V_{DS} = 30\text{ V}$ $V_{DS} = 30\text{ V}$, $T_c = 125\text{ °C}$			1 10	μA μA
I_{GSS}	Gate body leakage current ($V_{DS} = 0$)	$V_{GS} = \pm 20\text{ V}$			± 100	nA
$V_{GS(th)}$	Gate threshold voltage	$V_{DS} = V_{GS}$, $I_D = 250\ \mu\text{A}$	1			V
$R_{DS(on)}$	Static drain-source on-resistance	$V_{GS} = 10\text{ V}$, $I_D = 3\text{ A}$		0.021	0.025	Ω
		$V_{GS} = 4.5\text{ V}$, $I_D = 3\text{ A}$		0.032	0.036	Ω

Table 5. Dynamic

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
C_{iss}	Input capacitance		-	283	-	pF
C_{oss}	Output capacitance	$V_{DS} = 24\text{ V}$, $f = 1\text{ MHz}$, $V_{GS} = 0$	-	61	-	pF
C_{rss}	Reverse transfer capacitance		-	31	-	pF
Q_g	Total gate charge	$V_{DD} = 10\text{ V}$, $I_D = 6\text{ A}$	-	3.6	-	nC
Q_{gs}	Gate-source charge	$V_{GS} = 4.5\text{ V}$	-	1.5	-	nC
Q_{gd}	Gate-drain charge	Figure 14	-	1.1	-	nC

Table 6. Switching on/off (inductive load)

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$t_{d(on)}$	Turn-on delay time	$V_{DD} = 10\text{ V}$, $I_D = 3\text{ A}$, $R_G = 4.7\ \Omega$, $V_{GS} = 4.5\text{ V}$ Figure 13	-	4.8	-	ns
t_r	Rise time		-	11.2	-	ns
$t_{d(off)}$	Turn-off delay time		-	9.4	-	ns
t_f	Fall time		-	5.4	-	ns

Table 7. Source drain diode

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
I_{SD}	Source-drain current		-		6	A
$I_{SDM}^{(1)}$	Source-drain current (pulsed)		-		24	A
$V_{SD}^{(2)}$	Forward on voltage	$I_{SD} = 6\text{ A}$, $V_{GS} = 0$	-		1.1	V
t_{rr}	Reverse recovery time	$I_{SD} = 6\text{ A}$, $di/dt = 100\text{ A}/\mu\text{s}$, $V_{DD} = 16\text{ V}$, $T_J = 150\text{ }^\circ\text{C}$ Figure 15	-	10.6	-	ns
Q_{rr}	Reverse recovery charge		-	2.8	-	nC
I_{RRM}	Reverse recovery current		-	0.5	-	A

1. Pulse width limited by safe operating area
2. Pulsed: pulse duration = 300 μs , duty cycle 1.5%

2.1 Electrical characteristics (curves)

Figure 2. Safe operating area

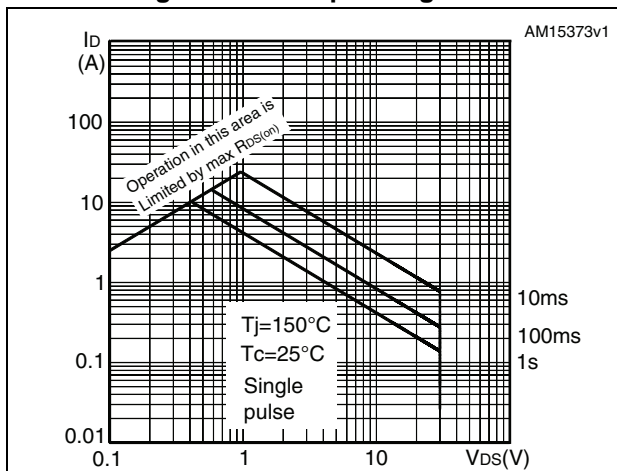


Figure 3. Thermal impedance

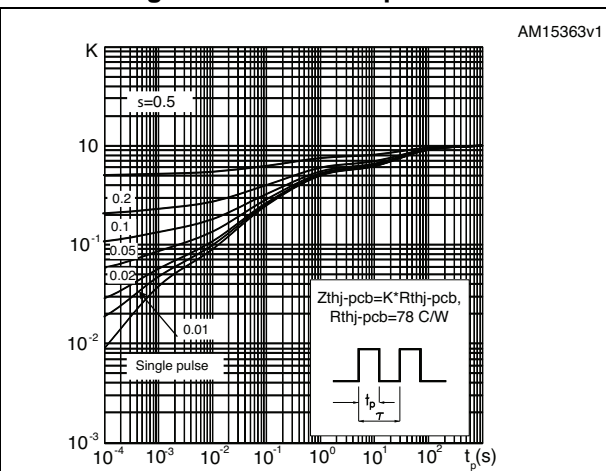


Figure 4. Output characteristics

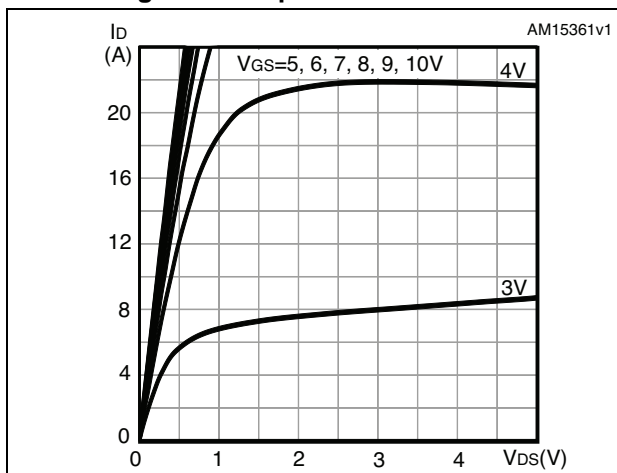


Figure 5. Transfer characteristics

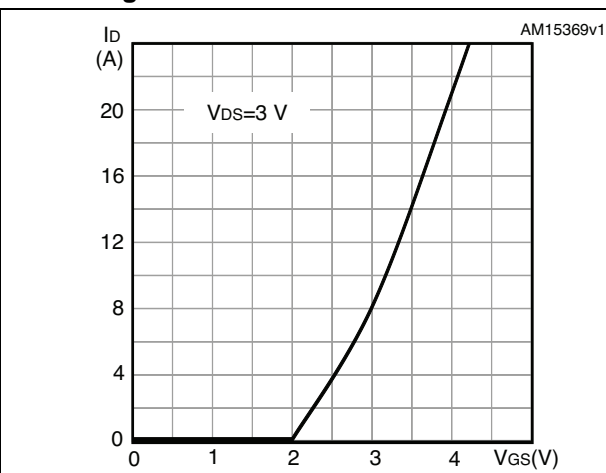


Figure 6. Gate charge vs gate-source voltage

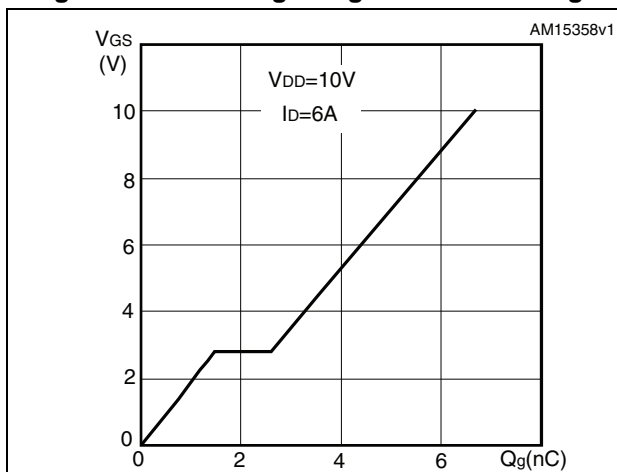


Figure 7. Static drain-source on-resistance

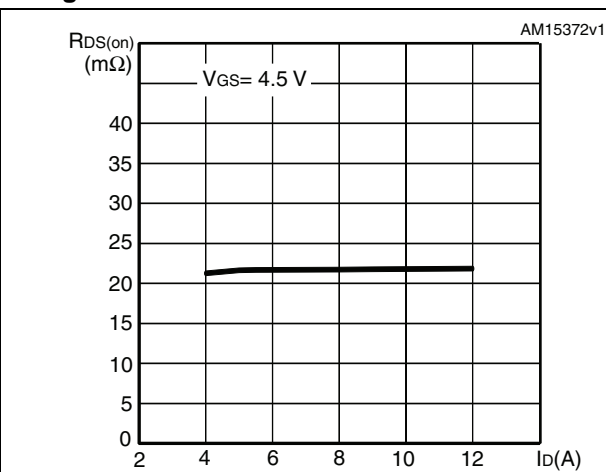


Figure 8. Capacitance variations

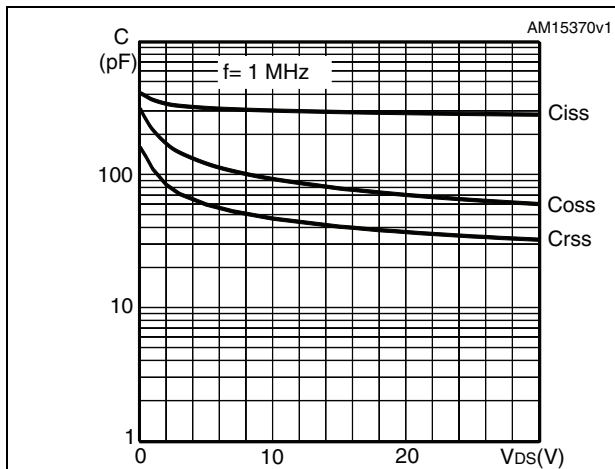


Figure 9. Normalized on-resistance vs temperature

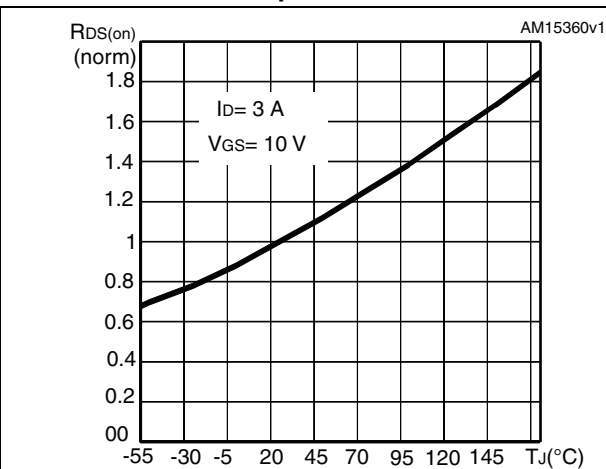


Figure 10. Normalized gate threshold voltage vs temperature

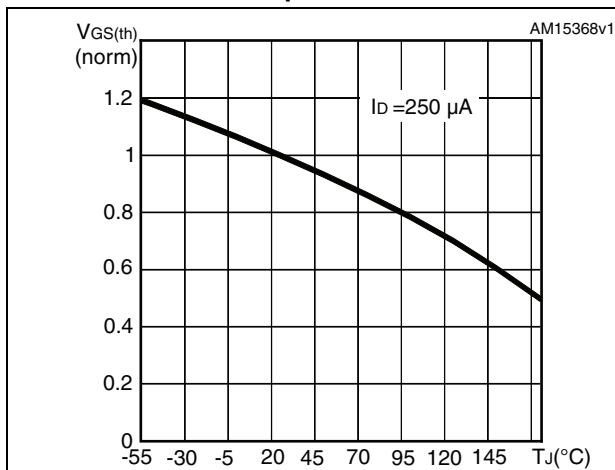


Figure 11. Normalized $V_{(BR)DSS}$ vs temperature

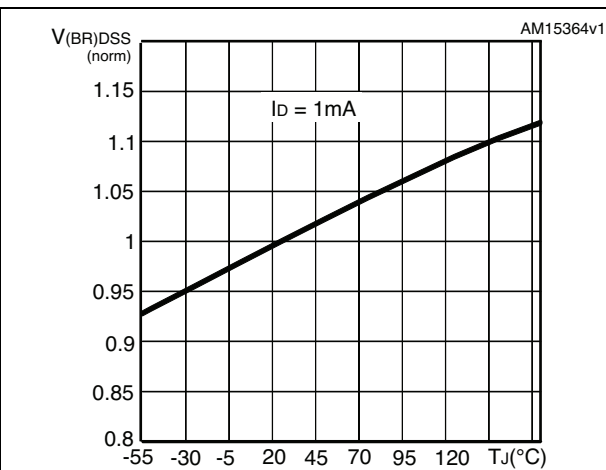
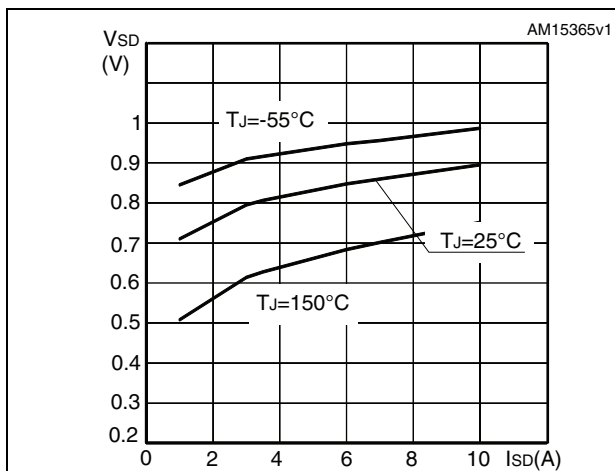


Figure 12. Source-drain diode forward characteristics



3 Test circuits

Figure 13. Switching times test circuit for resistive load



Figure 14. Gate charge test circuit



Figure 15. Test circuit for inductive load switching and diode recovery times



Figure 16. Unclamped inductive load test circuit



Figure 17. Unclamped inductive waveform



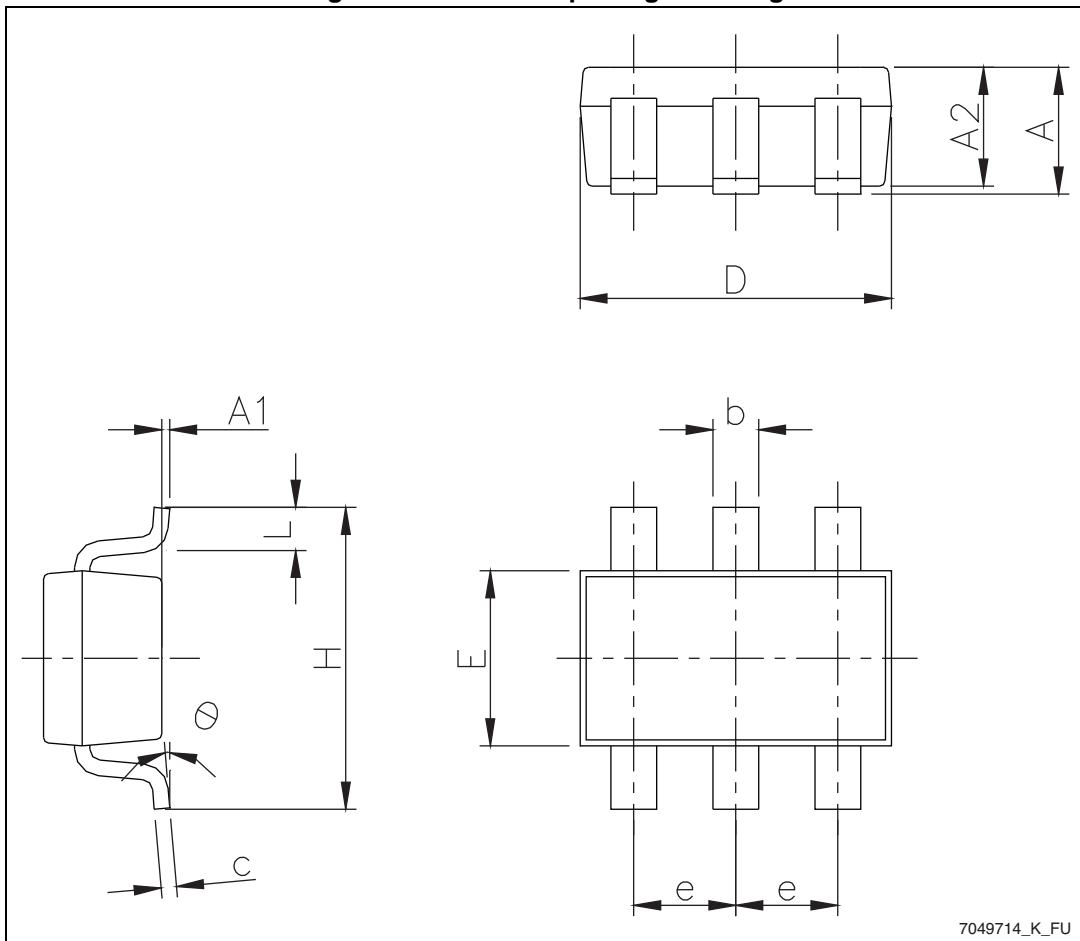
Figure 18. Switching time waveform



4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK® is an ST trademark.

Figure 19. SOT23-6L package drawing

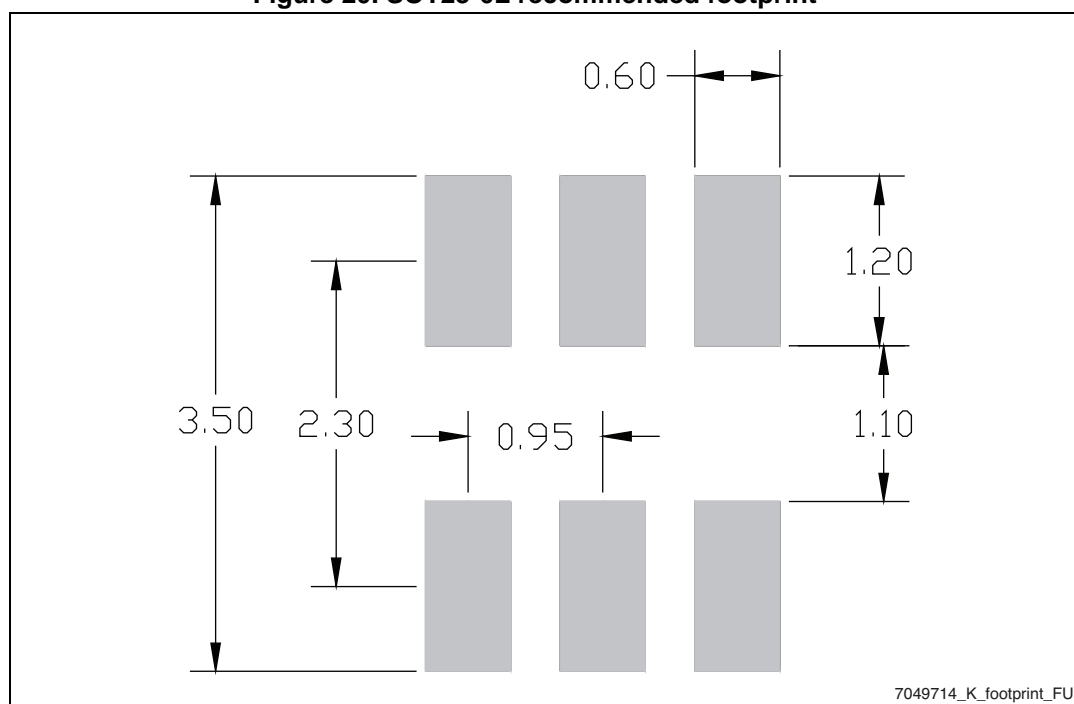


7049714_K_FU

Table 8. SOT23-6L package mechanical data

Dim.	mm		
	Min.	Typ.	Max.
A			1.25
A1	0.00		0.15
A2	1.00	1.10	1.20
b	0.36		0.50
C	0.14		0.20
D	2.826	2.926	3.026
E	1.526	1.626	1.726
e	0.90	0.95	1.00
H	2.60	2.80	3.00
L	0.35	0.45	0.60
θ	0°		8°

Figure 20. SOT23-6L recommended footprint^(a)



a. All dimensions are in millimeters

5 Revision history

Table 9. Document revision history

Date	Revision	Changes
11-Oct-2012	1	First release.
24-Oct-2013	2	Modified: $R_{DS(on)}$ value on : Features table and in Table 4 . Document status promoted from preliminary to production data.
11-Mar-2014	3	Updated Section 4: Package mechanical data . Minor text changes

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